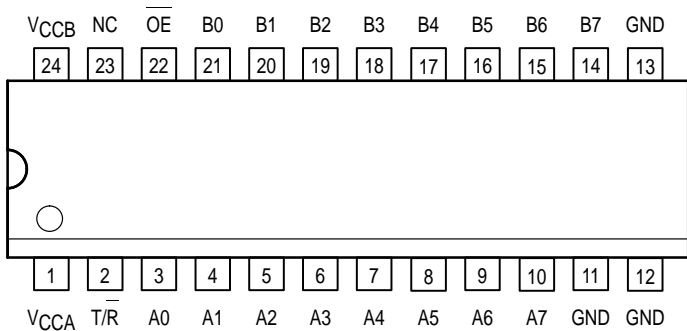


*Advance Information*  
**Configurable Dual Supply  
Octal Transceiver  
with 3-State Outputs for 3V Systems**

The 74LVXC3245 is a 24-pin dual-supply, octal configurable voltage interface transceiver especially well suited for PCMCIA and other real time configurable I/O applications. The  $V_{CCA}$  pin accepts a 3V supply level; the A port is a dedicated 3V port. The  $V_{CCB}$  pin accepts a 3V-to-5V supply level. The B port is configured to track the  $V_{CCB}$  supply level. A 5V level on the  $V_{CCB}$  pin will configure the I/O pins at a 5V level and a 3V  $V_{CCB}$  will configure the I/O pins at a 3V level. The A port interfaces with a 3V host system and the B port to the card slots. This device will allow the  $V_{CCB}$  voltage source pin and I/O pins on the B port to float when OE is High. This feature is necessary to buffer data to and from a PCMCIA socket that permits PCMCIA cards to be inserted and removed during normal operation. The Transmit/Receive (T/R) input determines the direction of data flow. Transmit (active-High) enables data from the A port to B port. Receive (active-Low) enables data from the B port to the A port.

- Bidirectional Interface Between 3V and 3V/5V Buses
- Control Inputs Compatible with TTL Level
- Outputs Source/Sink Up to 24mA
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- Available in SOIC and TSSOP Packages
- Flexible  $V_{CCB}$  Operating Range
- Allows B Port and  $V_{CCB}$  to Float Simultaneously When OE Is High
- Functionally Compatible with the 74 Series 245



**Figure 1. 24-Lead Pinout (Top View)**

**MC74LVXC3245**

**LVX**

**LOW-VOLTAGE CMOS**

**DW SUFFIX**  
24-LEAD PLASTIC WIDE SOIC PACKAGE  
CASE 751E-04

**DT SUFFIX**  
24-LEAD PLASTIC TSSOP PACKAGE  
CASE 948H-01

**PIN NAMES**

Pins	Function
$\overline{OE}$	Output Enable Input
T/R	Transmit/Receive Input
A0-A7	Side A 3-State Inputs or 3-State Outputs
B0-B7	Side B 3-State Inputs or 3-State Outputs

This document contains information on a new product. Specifications and information herein are subject to change without notice.

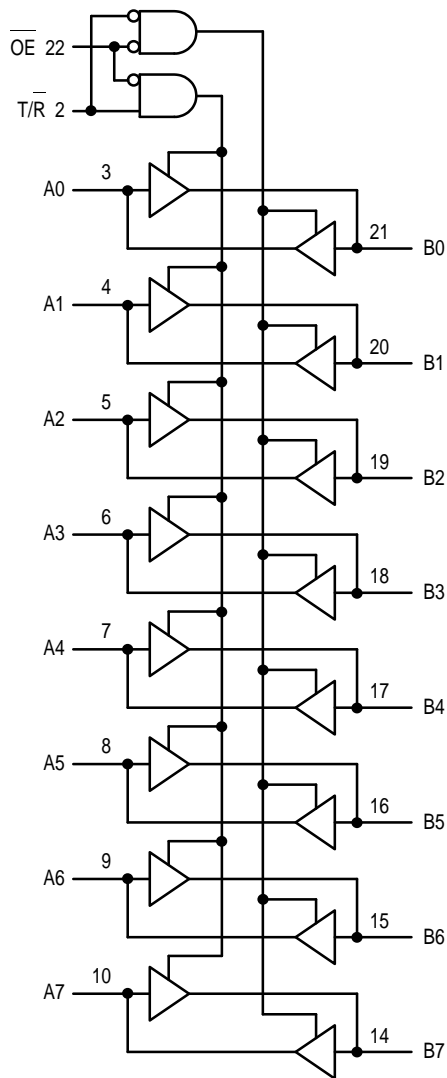


Figure 2. Logic Diagram

INPUTS		OPERATING MODE Non-Inverting
OE	T/R	
L	L	B Data to A Bus
L	H	A Data to B Bus
H	X	Z

H = High Voltage Level; L = Low Voltage Level; Z = High Impedance State; X = High or Low Voltage Level and Transitions are Acceptable; For I<sub>CC</sub> reasons, Do Not Float Inputs

**ABSOLUTE MAXIMUM RATINGS\***

Symbol	Parameter	Value	Condition	Unit	
V <sub>CCA</sub> , V <sub>CCB</sub>	DC Supply Voltage	-0.5 to +7.0		V	
V <sub>I</sub>	DC Input Voltage	OE, T/R	-0.5 to V <sub>CCA</sub> +0.5	V	
V <sub>I/O</sub>	DC Input/Output Voltage	An	-0.5 to V <sub>CCA</sub> +0.5	V	
		Bn	-0.5 to V <sub>CCB</sub> +0.5	V	
I <sub>IK</sub>	DC Input Diode Current	OE, T/R	±20	V <sub>I</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current		±50	V <sub>O</sub> < GND; V <sub>O</sub> > V <sub>CC</sub>	mA
I <sub>O</sub>	DC Output Source/Sink Current		±50		mA
I <sub>CC</sub> , I <sub>GND</sub>	DC Supply Current	Per Output Pin Maximum Current	±50 ±200		mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150		°C
	DC Latchup Source/Sink Current		±300		mA

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit	
V <sub>CCA</sub> , V <sub>CCB</sub>	Supply Voltage (V <sub>CCA</sub> ≤ V <sub>CCB</sub> )	V <sub>CCA</sub>	2.7	3.6	V
		V <sub>CCB</sub>	3.0	5.5	
V <sub>I</sub>	Input Voltage	OE, T/R	0	V <sub>CCA</sub>	V
V <sub>I/O</sub>	Input/Output Voltage	An	0	V <sub>CCA</sub>	V
		Bn	0	V <sub>CCB</sub>	
T <sub>A</sub>	Operating Free-Air Temperature		-40	+85	°C
Δt/ΔV	Minimum Input Edge Rate V <sub>IN</sub> from 30% to 70% of V <sub>CC</sub> ; V <sub>CC</sub> at 3.0V, 4.5V, 5.5V		0	8	ns/V

**DC ELECTRICAL CHARACTERISTICS**

Symbol	Parameter	Condition	V <sub>CCA</sub>	V <sub>CCB</sub>	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40 to +85°C		Unit
					Typ	Guaranteed Limits			
V <sub>IHA</sub>	Minimum HIGH Level Input Voltage	.An OE T/R	2.7	3.0		2.0	2.0	V	
			3.0	3.6		2.0	2.0		
			3.6	5.5		2.0	2.0		
V <sub>IHB</sub>		Bn	2.7	3.0		2.00	2.00	V	
			3.0	3.6		2.00	2.00		
			3.6	5.5		3.85	3.85		
V <sub>ILA</sub>	Maximum LOW Level Input Voltage	.An OE T/R	2.7	3.0		0.8	0.8	V	
			3.0	3.6		0.8	0.8		
			3.6	5.5		0.8	0.8		
V <sub>ILB</sub>		Bn	2.7	3.0		0.80	0.80	V	
			3.0	3.6		0.80	0.80		
			3.6	5.5		1.65	1.65		
V <sub>OHA</sub>	Minimum HIGH Level Output Voltage	I <sub>OUT</sub> = -100μA I <sub>OH</sub> = -12mA I <sub>OH</sub> = -24mA I <sub>OH</sub> = -12mA I <sub>OH</sub> = -24mA	3.0	3.0	2.99	2.90	2.90	V	
			3.0	3.0	2.85	2.56	2.46		
			3.0	3.0	2.65	2.35	2.25		
			2.7	3.0	2.50	2.30	2.20		
			2.7	4.5	2.30	2.10	2.00		
V <sub>OHB</sub>		I <sub>OUT</sub> = -100μA I <sub>OH</sub> = -12mA I <sub>OH</sub> = -24mA I <sub>OH</sub> = -24mA	3.0	3.0	2.99	2.90	2.90	V	
			3.0	3.0	2.85	2.56	2.46		
			3.0	3.0	2.65	2.35	2.25		
			3.0	4.5	4.25	3.86	3.76		
			3.0	4.5	4.25	3.86	3.76		

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	VCCA	VCCB	TA = 25°C		TA = -40 to +85°C		Unit
					Typ	Guaranteed Limits			
VOLA	Maximum LOW Level Output Voltage	I <sub>OUT</sub> = 100µA I <sub>OL</sub> = 24mA I <sub>OL</sub> = 12mA I <sub>OL</sub> = 24mA	3.0	3.0	0.002	0.10	0.10	V	
			3.0	3.0	0.21	0.36	0.44		
			2.7	3.0	0.11	0.36	0.44		
			2.7	4.5	0.22	0.42	0.50		
VOLB		I <sub>OUT</sub> = 100µA I <sub>OL</sub> = 24mA I <sub>OL</sub> = 24mA	3.0	3.0	0.002	0.10	0.10	V	
			3.0	3.0	0.21	0.36	0.44		
			3.0	4.5	0.18	0.36	0.44		
I <sub>IN</sub>	Max Input Leakage Current	OE, T/R V <sub>I</sub> = V <sub>CCA</sub> , GND	3.6 3.6	3.6 5.5		±0.1 ±0.1	±1.0 ±1.0	µA	
I <sub>OZA</sub>	Max 3-State Output Leakage	An V <sub>I</sub> = V <sub>IH</sub> , V <sub>IL</sub> OE = V <sub>CCA</sub> V <sub>O</sub> = V <sub>CCA</sub> , GND	3.6 3.6	3.6 5.5		±0.5 ±0.5	±5.0 ±5.0	µA	
I <sub>OZB</sub>	Max 3-State Output Leakage	Bn V <sub>I</sub> = V <sub>IH</sub> , V <sub>IL</sub> OE = V <sub>CCA</sub> V <sub>O</sub> = V <sub>CCB</sub> , GND	3.6 3.6	3.6 5.5		±0.5 ±0.5	±5.0 ±5.0	µA	
ΔI <sub>CC</sub>	Maximum I <sub>CC</sub> /Input	Bn V <sub>I</sub> = V <sub>CCB</sub> - 2.1V	3.6	5.5	1.0	1.35	1.5	mA	
		All Inputs V <sub>I</sub> = V <sub>CC</sub> - 0.6V	3.6	3.6		0.35	0.5	mA	
I <sub>CCA1</sub>	Quiescent V <sub>CCA</sub> Supply Current as B Port Floats	An = V <sub>CCA</sub> or GND Bn = Open, OE = V <sub>CCA</sub> , T/R = V <sub>CCA</sub> , V <sub>CCB</sub> = Open	3.6	Open		5	50	µA	
I <sub>CCA2</sub>	Quiescent V <sub>CCA</sub> Supply Current	An = V <sub>CCA</sub> or GND Bn = V <sub>CCB</sub> or GND, OE = GND, T/R = GND	3.6	3.6		5	50	µA	
			3.6	5.5		5	50		
I <sub>CCB</sub>	Quiescent V <sub>CCB</sub> Supply Current	An = V <sub>CCA</sub> or GND Bn = V <sub>CCB</sub> or GND, OE = GND, T/R = V <sub>CCA</sub>	3.6	3.6		5	50	µA	
			3.6	5.5		8	80		
V <sub>OLPA</sub>	Quiet Output Max Dynamic V <sub>OL</sub>	Notes NO TAG, NO TAG	3.3	3.3		0.8		V	
			3.3	5.0		0.8			
V <sub>OLPB</sub>		Notes NO TAG, NO TAG	3.3	3.3		0.8		V	
			3.3	5.0		1.5			
V <sub>OLVA</sub>	Quiet Output Min Dynamic V <sub>OL</sub>	Notes NO TAG, NO TAG	3.3	3.3		-0.8		V	
			3.3	5.0		-0.8			
V <sub>OLVB</sub>		Notes NO TAG, NO TAG	3.3	3.3		-0.8		V	
			3.3	5.0		-1.2			
V <sub>IHDA</sub>	Min HIGH Level Dynamic Input Voltage	Notes NO TAG, NO TAG	3.3	3.3		2.0		V	
			3.3	5.0		2.0			
V <sub>IHDB</sub>		Notes NO TAG, NO TAG	3.3	3.3		2.0		V	
			3.3	5.0		3.5			
V <sub>ILDA</sub>	Max LOW Level Dynamic Input Voltage	Notes NO TAG, NO TAG	3.3	3.3		0.8		V	
			3.3	5.0		0.8			
V <sub>ILDB</sub>		Notes NO TAG, NO TAG	3.3	3.3		0.8		V	
			3.3	5.0		1.5			

1. Worst case package.
2. Max number of outputs defined as (n). Data inputs are driven 0V to V<sub>CC</sub> level; one output at GND.
3. Max number of data inputs (n) switching. (n-1) inputs switching 0V to V<sub>CC</sub> level. Input under test switching: V<sub>CC</sub> level to threshold (V<sub>IHD</sub>), 0V to threshold (V<sub>ILD</sub>), f = 1MHz.

## AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	$T_A = -40$ to $+85^\circ\text{C}$ ; $C_L = 50\text{pF}$						Unit
		$V_{CCA} = 2.7\text{--}3.6\text{V}$ $V_{CCB} = 4.5\text{--}5.5\text{V}$			$V_{CCA} = 2.7\text{--}3.6\text{V}$ $V_{CCB} = 3.0\text{--}3.6\text{V}$			
		Min	Typ (Note 4.)	Max	Min	Typ (Note 5.)	Max	
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay A to B	1.0 1.0	4.8 3.9	8.5 7.0	1.0 1.0	5.5 5.2	9.0 8.5	ns
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay B to A	1.0 1.0	3.8 4.3	7.0 8.0	1.0 1.0	4.4 5.1	7.5 8.0	ns
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time OE to B	1.0 1.0	4.7 4.8	8.5 9.0	1.0 1.0	6.0 6.1	9.5 10.0	ns
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time OE to A	1.0 1.0	5.9 5.4	10.0 9.5	1.0 1.0	6.4 5.8	10.5 9.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time OE to B	1.0 1.0	4.0 3.8	8.5 8.0	1.0 1.0	6.3 4.5	10.0 8.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time OE to A	1.0 1.0	4.6 3.1	10.0 7.0	1.0 1.0	5.2 3.4	10.0 7.0	ns
t <sub>OSSL</sub> t <sub>OSLH</sub>	Output to Output Skew, Data to Output (Note NO TAG)		1.0	1.5		1.0	1.5	ns

4. Typical values at  $V_{CCA} = 3.3\text{V}$ ,  $V_{CCB} = 5.0\text{V}$  at  $25^\circ\text{C}$ .

5. Typical values at  $V_{CCA} = 3.3\text{V}$ ,  $V_{CCB} = 3.3\text{V}$  at  $25^\circ\text{C}$ .

6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSSL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ); parameter guaranteed by design.

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CCA} = 3.3\text{V}$ ; $V_{CCB} = 5.0\text{V}$	4.5	pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CCA} = 3.3\text{V}$ ; $V_{CCB} = 5.0\text{V}$	10	pF
CPD	Power Dissipation Capacitance (Measured at 10MHz)	A→B B→A $V_{CCB} = 5.0\text{V}$ $V_{CCA} = 3.3\text{V}$	50 40	pF

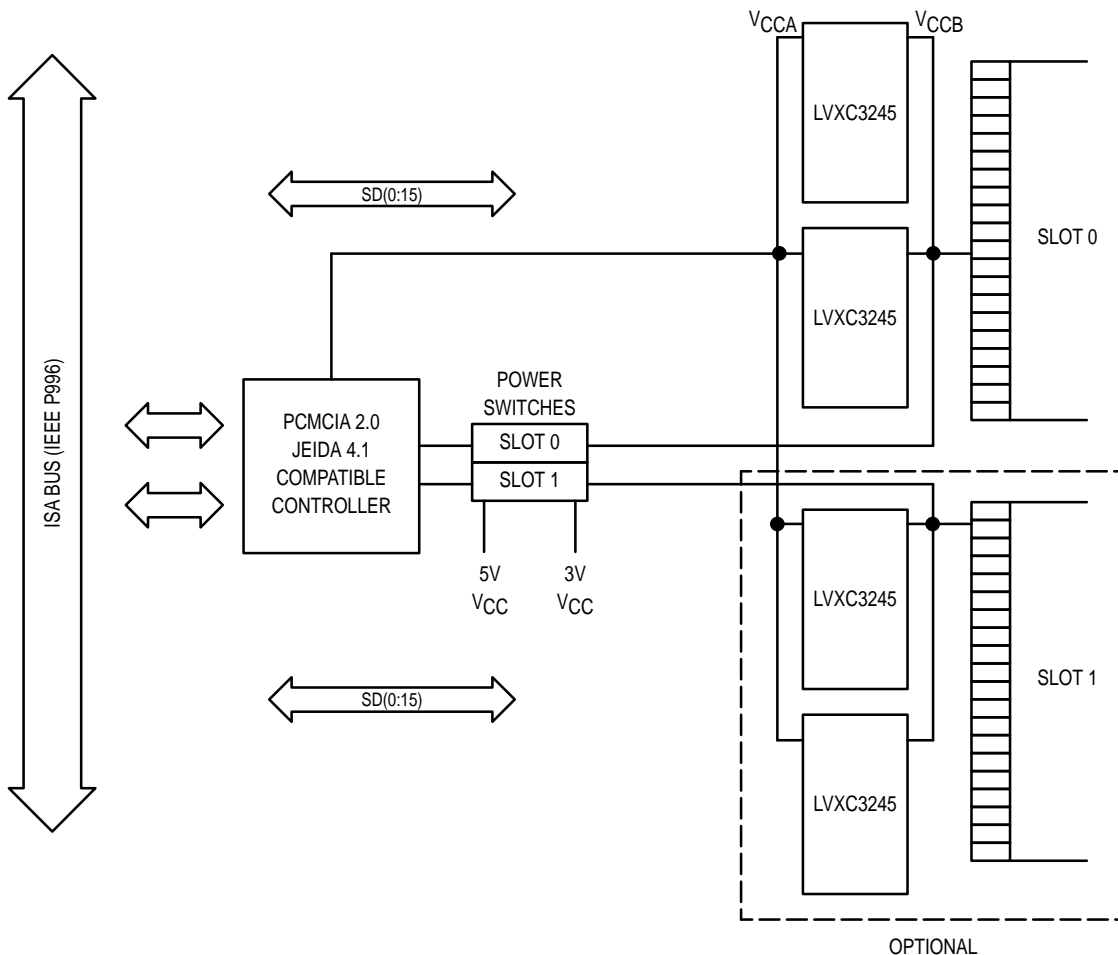


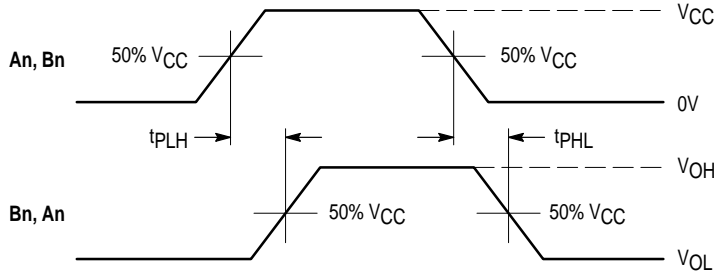
Figure 3. Block Diagram

**Configurable I/O Application for PCMCIA Cards**

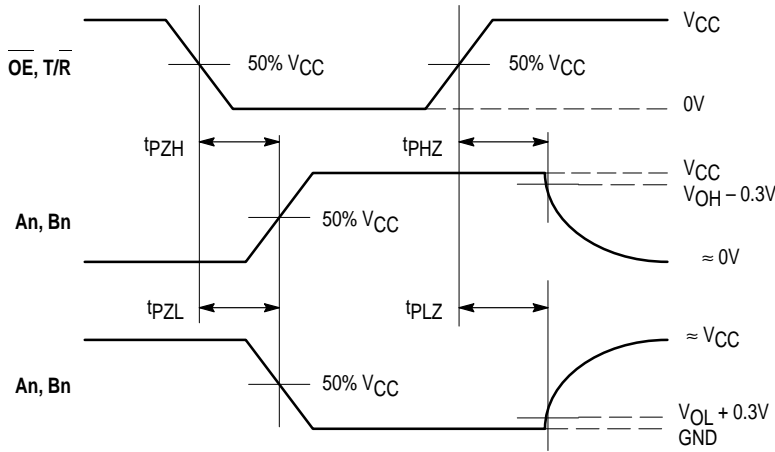
The 74LVXC3245 is a dual-supply device well suited for PCMCIA configurable I/O applications. The LVXC3245 consumes less than 1mW of quiescent power in all modes of operation, making it ideal for low power notebook designs. The LVXC3245 meets all PCMCIA I/O voltage requirements at 5V and 3.3V operation. By tying the VCCB pin to the card

voltage supply, the PCMCIA card will always have rail-to-rail output swings, maximizing the reliability of the interface.

The VCCA pin must always be tied to a 3.3V power supply. This voltage connection provides internal references needed to account for variations in VCCB. When connected as in the figure above, the LVXC3245 meets all the voltage and current requirements of the ISA bus standard (IEEE P996).

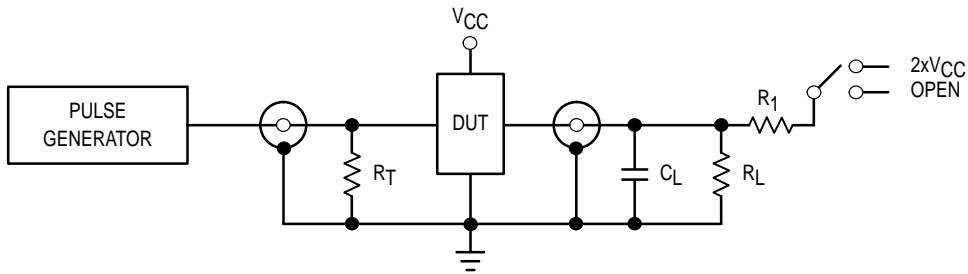


**WAVEFORM 1 - PROPAGATION DELAYS**  
 $t_R = t_F = 2.5\text{ns}$ , 10% to 90%;  $f = 1\text{MHz}$ ;  $t_W = 500\text{ns}$



**WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES**  
 $t_R = t_F = 2.5\text{ns}$ , 10% to 90%;  $f = 1\text{MHz}$ ;  $t_W = 500\text{ns}$

**Figure 4. AC Waveforms**



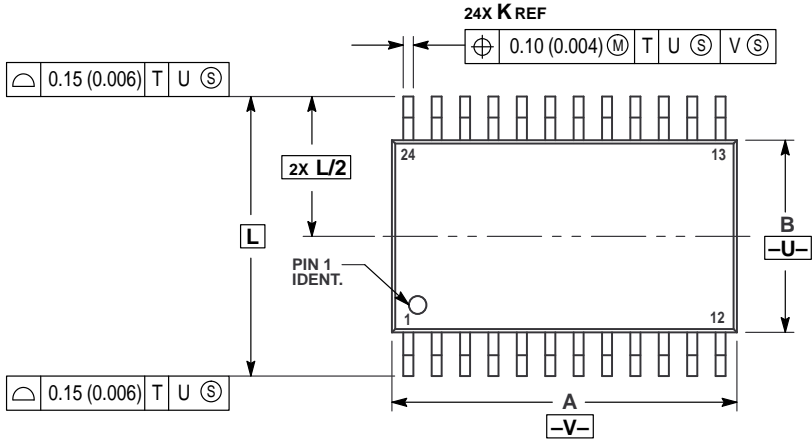
TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$ , $t_{PZH}$ , $t_{PHZ}$	Open
$t_{PZL}$ , $t_{PLZ}$	$2 \times V_{CC}$

$C_L = 50\text{pF}$  or equivalent (Includes jig and probe capacitance)  
 $R_L = R_1 = 500\Omega$  or equivalent  
 $R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

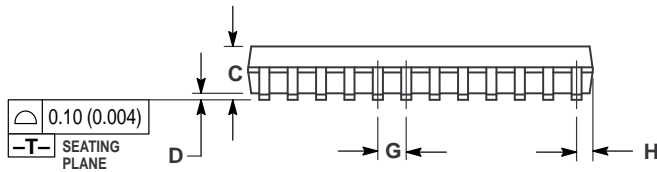
**Figure 5. Test Circuit**

OUTLINE DIMENSIONS

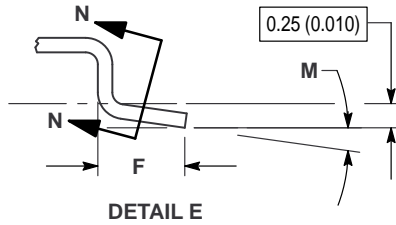
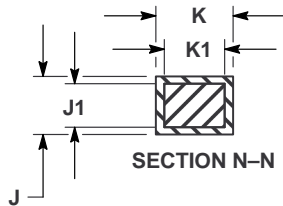
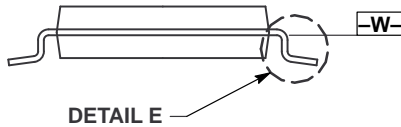
DT SUFFIX  
 PLASTIC TSSOP PACKAGE  
 CASE 948H-01  
 ISSUE O



- NOTES:
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - 2 CONTROLLING DIMENSION: MILLIMETER.
  - 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  - 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  - 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  - 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  - 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.



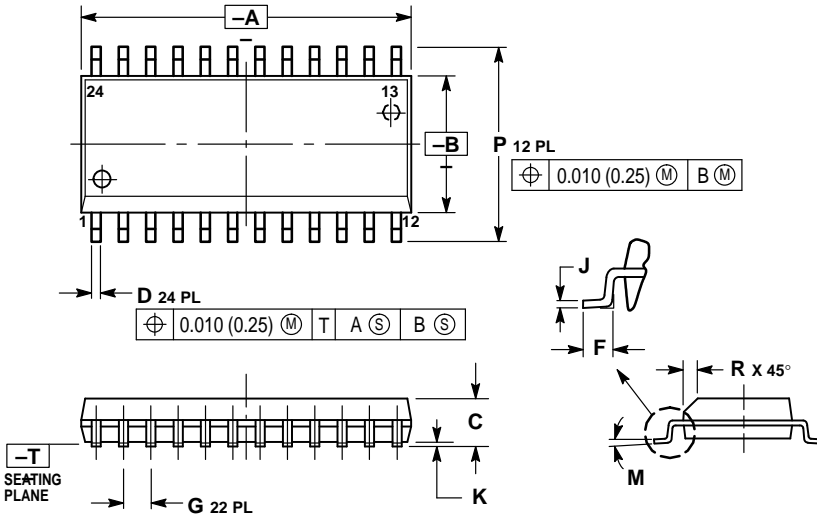
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°





OUTLINE DIMENSIONS


DW SUFFIX  
PLASTIC SOIC PACKAGE  
CASE 751E-04  
ISSUE E



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and  are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

Mfax is a trademark of Motorola, Inc.

How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 5405, Denver, Colorado 80217. 303-675-2140 or 1-800-441-2447

JAPAN: Nippon Motorola Ltd.: SPD, Strategic Planning Office, 4-32-1, Nishi-Gotanda, Shinagawa-ku, Tokyo 141, Japan. 81-3-5487-8488

Mfax™: RMFAX0@email.sps.mot.com – TOUCHTONE 602-244-6609  
– US & Canada ONLY 1-800-774-1848

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

INTERNET: <http://motorola.com/sps>

